

#	Layer	Thickness	Description	Dk	Df	Note
	Top Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
1	Top Side	0.035mm	Starting foil 1/2oz. after plating and processing			
		0.220mm	Prepreg IPC-4101/21	3,9	0,02	FR-4.0
2	Inner Layer 1	0.035mm	ED Base Copper			
		0.150mm	Core IPC-4101/21	3,9	0,02	FR-4.0
3	Inner Layer 2	0.035mm	ED Base Copper			
		0.220mm	Prepreg IPC-4101/21	3,9	0,02	FR-4.0
4	Inner Layer 3	0.035mm	ED Base Copper			
		0.150mm	Core IPC-4101/21	3,9	0,02	FR-4.0
5	Inner Layer 4	0.035mm	ED Base Copper			
		0.220mm	Prepreg IPC-4101/21	3,9	0,02	FR-4.0
6	Inner Layer 5	0.035mm	ED Base Copper			
		0.150mm	Core IPC-4101/21	3,9	0,02	FR-4.0
7	Inner Layer 6	0.035mm	ED Base Copper			
		0.220mm	Prepreg IPC-4101/21	3,9	0,02	FR-4.0
8	Bottom Side	0.035mm	Starting foil 1/2oz. after plating and processing			
	Bottom Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts

Total thickness: 1.640mm

notes:

Final copper thickness according to IPC-6012

Please regard to our sectional design rules:
▶ www.we-online.com

BASIC8_ML8_1,64_35_V2.12

PCB Thickness Tolerance: ± 10%

customer	created		
pcb name	approved		
engineer	format	A4, landscape	
date			

Template Revision: 02/2021 by Andreas Schilpp / Michael Kress / Werner Öchslen

